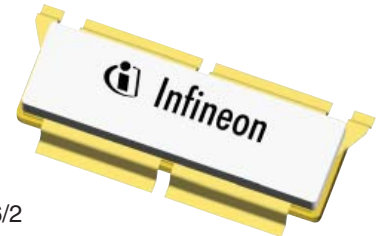


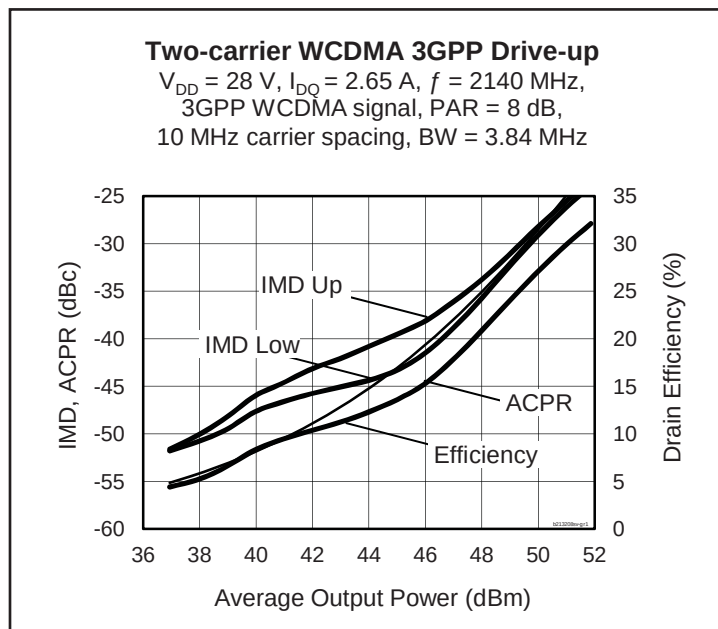
Thermally-Enhanced High Power RF LDMOS FET 320 W, 28 V, 2110 – 2170 MHz

Description

The PTFB213208SV is a 320-watt LDMOS FET intended for use in multi-standard cellular power amplifier applications in the 2110 to 2170 MHz frequency band. Features include input and output matching, high gain and thermally-enhanced package with earless flange. Manufactured with Infineon's advanced LDMOS process, this device provides excellent thermal performance and superior reliability.



PTFB213208SV
Package H-34275-6/2



Features

- Broadband internal matching
- Wide video bandwidth
- Typical pulsed CW performance, 2140 MHz, 28 V (combined outputs)
 - Output power @ P_{1dB} = 343 W
 - Efficiency = 54%
 - Gain = 16.5 dB
- Typical single-carrier WCDMA performance, 2140 MHz, 28 V
 - Output power = 50 dBm avg
 - Gain = 17 dB
 - Efficiency = 32%
- Capable of handling 10:1 VSWR @ 28 V, 320 W (CW) output power
- Integrated ESD protection
- Low thermal resistance
- Pb-free and RoHS compliant

RF Characteristics

Single-carrier WCDMA Measurements (tested in Infineon test fixture)

$V_{DD} = 28\text{ V}$, $I_{DQ} = 2.6\text{ A}$, $P_{OUT} = 85\text{ W}$ average, $f = 2170\text{ MHz}$
 3GPP WCDMA signal, 3.84 MHz channel bandwidth, peak/average = 10 dB @ 0.01% CCDF

Characteristic	Symbol	Min	Typ	Max	Unit
Gain	Gps	15.75	17	—	dB
Drain Efficiency	η_D	29	32	—	%
Adjacent Channel Power Ratio	ACPR	—	-35	-29.5	dBc

All published data at $T_{CASE} = 25^\circ\text{C}$ unless otherwise indicated

ESD: Electrostatic discharge sensitive device—observe handling precautions!

DC Characteristics (both sides)

Characteristic	Conditions	Symbol	Min	Typ	Max	Unit
Drain-Source Breakdown Voltage	$V_{GS} = 0\text{ V}$, $I_{DS} = 10\text{ mA}$	$V_{(BR)DSS}$	65	—	—	V
Drain Leakage Current	$V_{DS} = 28\text{ V}$, $V_{GS} = 0\text{ V}$	I_{DSS}	—	—	1.0	μA
	$V_{DS} = 63\text{ V}$, $V_{GS} = 0\text{ V}$	I_{DSS}	—	—	10.0	μA
On-State Resistance	$V_{GS} = 10\text{ V}$, $V_{DS} = 0.1\text{ V}$	$R_{DS(on)}$	—	0.05	—	Ω
Operating Gate Voltage	$V_{DS} = 28\text{ V}$, $I_{DQ} = 2.6\text{ A}$	V_{GS}	2.3	2.8	3.3	V
Gate Leakage Current	$V_{GS} = 10\text{ V}$, $V_{DS} = 0\text{ V}$	I_{GSS}	—	—	1.0	μA

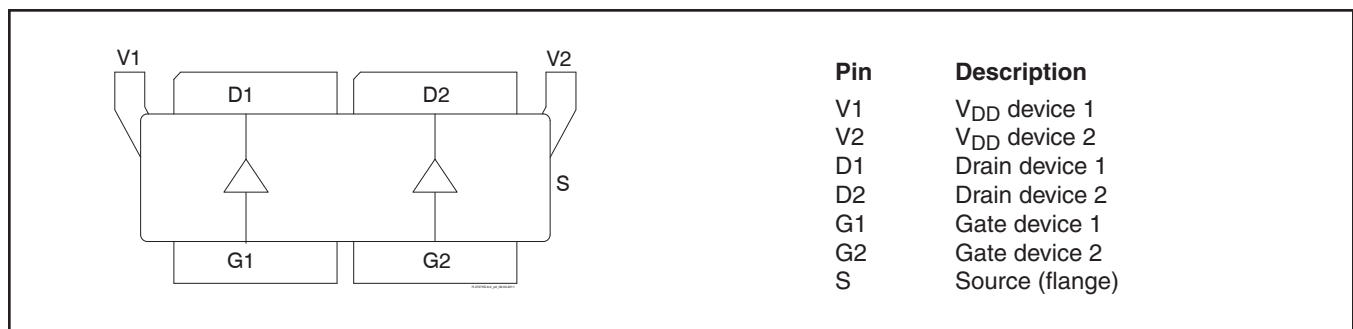
Maximum Ratings

Parameter	Symbol	Value	Unit
Drain-Source Voltage	V_{DSS}	65	V
Gate-Source Voltage	V_{GS}	−6 to +10	V
Junction Temperature	T_J	200	$^{\circ}\text{C}$
Storage Temperature Range	T_{STG}	−40 to +150	$^{\circ}\text{C}$
Thermal Resistance ($T_{CASE} = 70^{\circ}\text{C}$)	$R_{\theta JC}$	0.20	$^{\circ}\text{C/W}$

Ordering Information

Type and Version	Package Outline	Package Description	Shipping
PTFB213208SV V1 R250	PTFB213208SVV1R250XTMA1	H-34275-6/2, Ceramic open-cavity, push-pull earless	Tape & Reel, 250 pcs

Pinout Diagram (top view)

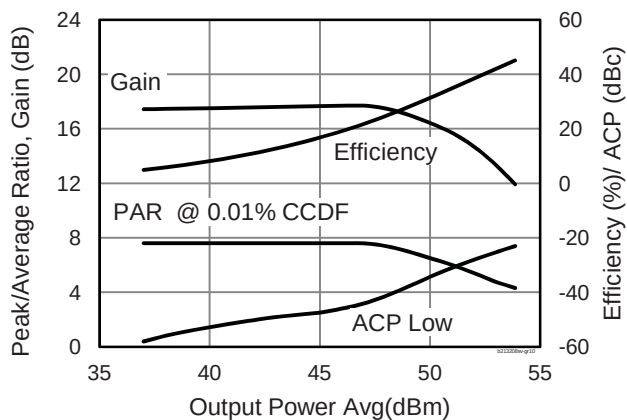


Lead connections for PTFB213208SV

Typical Performance (data taken in a production test fixture)

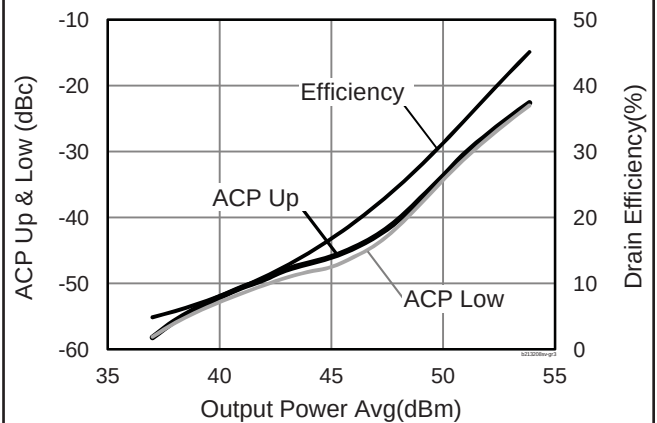
Single-carrier WCDMA 3GPP Drive-up

$V_{DD} = 28V$, $I_{DQ} = 2.7A$, $f = 2170\text{ MHz}$
 3GPP WCDMA signal,
 PAR = 7.5 dB, 3.84 MHz BW



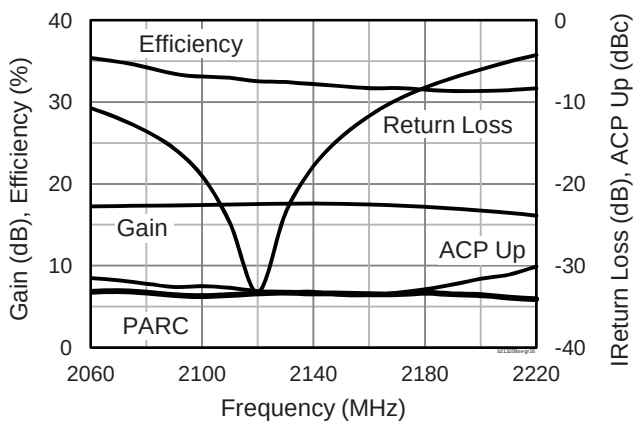
Single-carrier WCDMA 3GPP Drive-up

$V_{DD} = 28V$, $I_{DQ} = 2.7A$, $f = 2170\text{ MHz}$,
 3GPP WCDMA signal, PAR = 7.5 dB,
 BW = 3.84 MHz



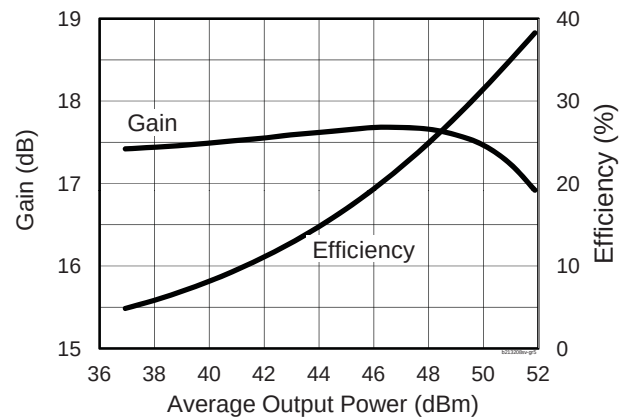
Single-carrier WCDMA 3GPP Broadband

$V_{DD} = 28V$, $I_{DQ} = 2.7A$, $P_{OUT} = 100W$



Two-carrier WCDMA 3GPP Drive-up

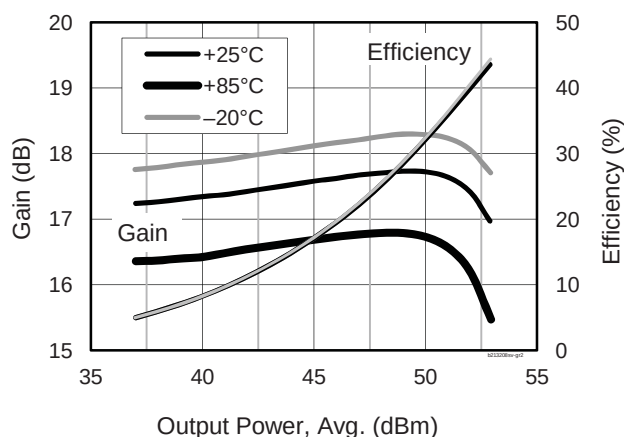
$V_{DD} = 28V$, $I_{DQ} = 2.65A$, $f = 2170\text{ MHz}$,
 3GPP WCDMA signal, PAR = 8 dB,
 10 MHz carrier spacing, BW = 3.84 MHz



Typical Performance (cont.)

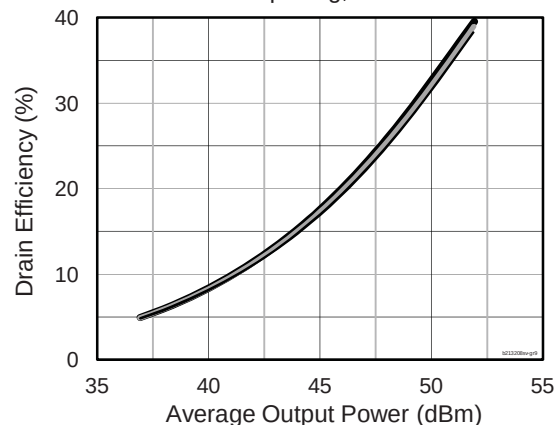
Two-tone Drive-up (over temperature)

$V_{DD} = 28\text{ V}$, $I_{DQ} = 2.7\text{ A}$,
 $f_1 = 2139.5\text{ MHz}$, $f_2 = 2140.5\text{ MHz}$



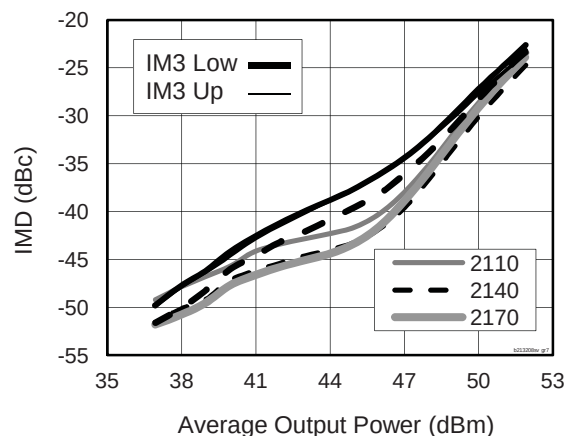
Two-carrier WCDMA 3GPP Drive-up

$V_{DD} = 28\text{ V}$, $I_{DQ} = 2.7\text{ A}$,
 $f = 2110, 2140, 2170\text{ MHz}$,
 3GPP WCDMA signal, PAR = 8 dB,
 10 MHz carrier spacing, BW = 3.84 MHz



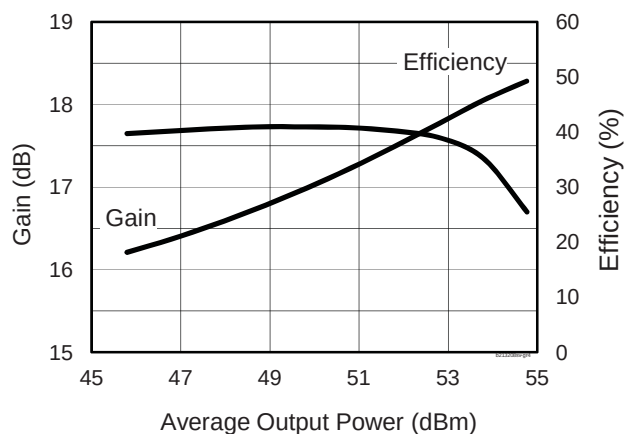
Two-carrier WCDMA 3GPP Drive-up

$V_{DD} = 30\text{ V}$, $I_{DQ} = 2.65\text{ A}$,
 3GPP WCDMA, PAR = 8 dB,
 10 MHz carrier spacing, BW = 3.84 MHz



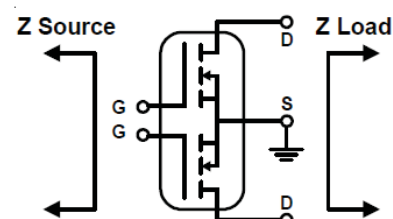
CW Drive-up

$V_{DD} = 28\text{ V}$, $I_{DQ} = 2.7\text{ A}$, $f = 2170\text{ MHz}$



Broadband Circuit Impedance

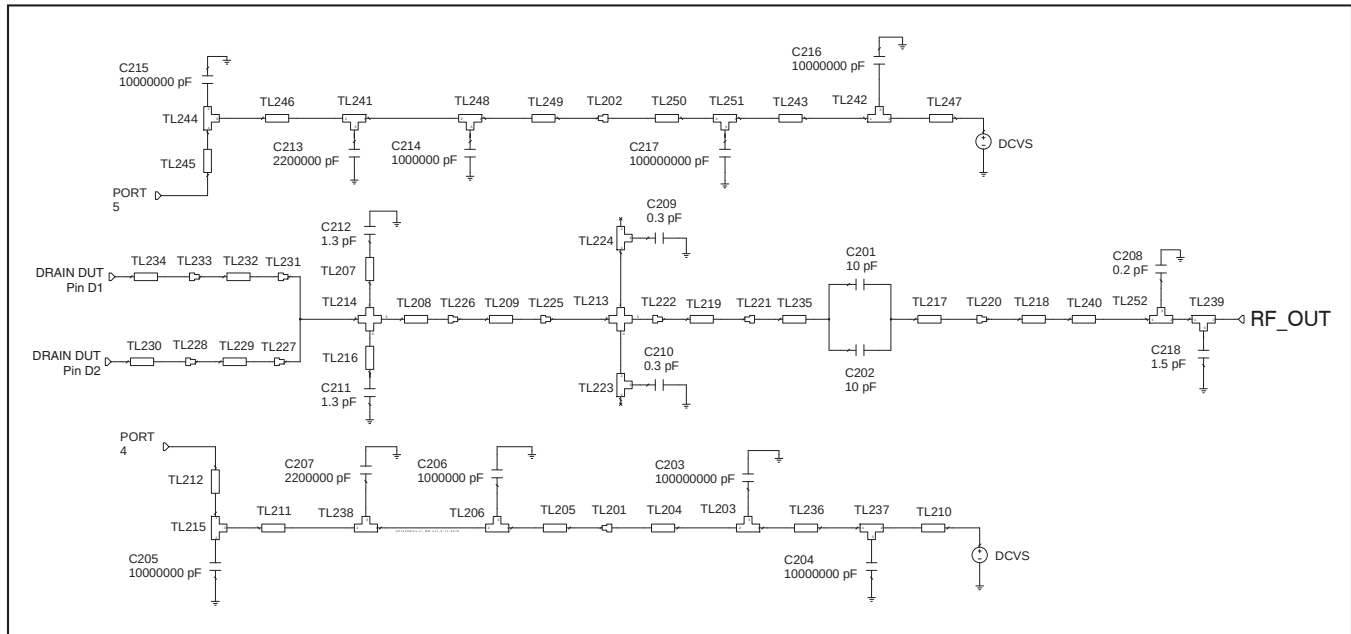
Frequency MHz	Z Source Ω		Z Load Ω	
	R	jX	R	jX
2080	2.84	-5.14	0.97	-2.70
2090	2.82	-5.14	0.95	-2.69
2100	2.79	-5.15	0.93	-2.67
2110	2.77	-5.15	0.92	-2.65
2120	2.74	-5.16	0.90	-2.64
2130	2.71	-5.16	0.88	-2.62
2140	2.67	-5.17	0.86	-2.60
2150	2.64	-5.18	0.85	-2.58
2160	2.60	-5.18	0.83	-2.56
2170	2.57	-5.19	0.81	-2.54
2180	2.53	-5.19	0.79	-2.53
2190	2.48	-5.19	0.78	-2.51
2200	2.44	-5.19	0.76	-2.48



See next page for reference circuit information

Reference circuit input schematic for $f = 2170$ MHz

Reference Circuit (cont.)



Reference circuit output schematic for $f = 2170$ MHz

Reference Circuit Assembly

DUT PTFB213208SV

Test Fixture Part No. LTN/PTFB213208SV

PCB Rogers RO4350, 0.508 mm [0.020"] thick, 2 oz. copper, $\epsilon_r = 3.48$

Find Gerber files for this test fixture on the Infineon Web site at <http://www.infineon.com/rfpower>

Electrical Characteristics at 2170 MHz

Transmission Line	Electrical Characteristics	Dimensions: mm	Dimensions: mils
Input			
TL101	0.006λ , 62.65Ω	$W = 0.76$, $L = 0.51$	$W = 30$, $L = 30$
TL102	0.010λ , 28.26Ω	$W = 2.54$, $L = 0.76$	$W = 100$, $L = 100$
TL103	0.171λ , 62.65Ω	$W = 0.76$, $L = 14.2$	$W = 30$, $L = 30$
TL104	0.010λ , 62.65Ω	$W = 0.76$, $L = 0.81$	$W = 30$, $L = 30$
TL105	0.020λ , 53.11Ω	$W = 1.02$, $L = 1.65$	$W = 40$, $L = 40$
TL106	0.072λ , 7.13Ω	$W = 12.7$, $L = 5.36$	$W = 500$, $L = 500$
TL107	0.017λ , 7.13Ω	$W = 12.7$, $L = 1.3$	$W = 500$, $L = 500$
TL108	0.026λ , 31.94Ω	$W = 2.16$, $L = 2.03$	$W = 85$, $L = 85$
TL109	0.061λ , 48.71Ω	$W = 1.17$, $L = 5.02$	$W = 46$, $L = 46$
TL110	0.006λ , 48.71Ω	$W = 1.17$, $L = 0.51$	$W = 46$, $L = 46$
TL120	0.010λ , 28.26Ω	$W = 2.54$, $L = 0.76$	$W = 100$, $L = 100$
TL121	0.023λ , 16.69Ω	$W = 4.88$, $L = 1.78$	$W = 192$, $L = 192$
TL122	0.072λ , 7.13Ω	$W = 12.7$, $L = 5.36$	$W = 500$, $L = 500$

(table cont. next page)

Reference Circuit (cont.)

Electrical Characteristics at 2170 MHz (Input cont.)

Transmission Line	Electrical Characteristics	Dimensions: mm	Dimensions: mils
TL123	0.043λ , 62.65Ω	$W = 0.76$, $L = 3.56$	$W = 30$, $L = 30$
TL124, TL136	0.016λ , 33.39Ω	$W = 2.03$, $L = 1.27$	$W = 80$, $L = 80$
TL125	0.023λ , 16.69Ω	$W = 4.88$, $L = 1.78$	$W = 192$, $L = 192$
TL126	0.031λ , 62.65Ω	$W = 0.76$, $L = 2.54$	$W = 30$, $L = 30$
TL127	0.011λ , 62.65Ω	$W = 0.76$, $L = 0.89$	$W = 30$, $L = 30$
TL128, TL130	0.006λ , 53.11Ω	$W = 1.02$, $L = 0.51$	$W = 40$, $L = 40$
TL129	0.019λ , 53.11Ω	$W = 1.02$, $L = 1.53$	$W = 40$, $L = 40$
TL131, TL157	0.017λ , 53.11Ω	$W = 1.02$, $L = 1.42$	$W = 40$, $L = 40$
TL132, TL133	0.009λ , 53.11Ω	$W = 1.02$, $L = 0.76$	$W = 40$, $L = 40$
TL134	0.100λ , 53.11Ω	$W = 1.02$, $L = 8.2$	$W = 40$, $L = 40$
TL135	0.045λ , 62.65Ω	$W = 0.76$, $L = 3.71$	$W = 30$, $L = 30$
TL137	0.003λ , 62.65Ω	$W = 0.76$, $L = 0.28$	$W = 30$, $L = 30$
TL138	0.027λ , 28.26Ω	$W1 = 2.54$, $W2 = 2.54$, $W3 = 2.16$	$W1 = 100$, $W2 = 100$, $W3 = 85$
TL139, TL142	0.014λ , 7.13Ω	$W1 = 12.7$, $W2 = 12.7$, $W3 = 1.02$	$W1 = 500$, $W2 = 500$, $W3 = 40$
TL140, TL141, TL143, TL144	0.015λ , 62.65Ω	$W1 = 0.76$, $W2 = 0.76$, $W3 = 1.27$	$W1 = 30$, $W2 = 30$, $W3 = 50$
TL145	0.012λ , 62.65Ω	$W1 = 0.76$, $W2 = 0.76$, $W3 = 1.02$	$W1 = 30$, $W2 = 30$, $W3 = 40$
TL150	0.102λ , 53.11Ω	$W = 1.02$, $L = 8.36$	$W = 40$, $L = 40$
TL151, TL156	0.015λ , 53.11Ω	$W1 = 1.02$, $W2 = 1.02$, $W3 = 1.27$	$W1 = 40$, $W2 = 40$, $W3 = 50$
TL152	0.016λ , 48.71Ω	$W1 = 1.17$, $W2 = 1.17$, $W3 = 1.27$	$W1 = 46$, $W2 = 46$, $W3 = 50$
TL153	0.012λ , 48.71Ω	$W = 1.17$, $L = 0.97$	$W = 46$, $L = 46$
TL154	0.017λ , 7.13Ω	$W = 12.7$, $L = 1.3$	$W = 500$, $L = 500$
TL155	0.009λ , 46.18Ω	$W1 = 1.27$, $W2 = 0.76$, $W3 = 1.27$, $W4 = 1.27$	$W1 = 50$, $W2 = 50$, $W3 = 50$, $W4 = 30$

Output

TL203	0.027λ , 11.33Ω	$W1 = 7.62$, $W2 = 7.62$, $W3 = 2.03$	$W1 = 300$, $W2 = 300$, $W3 = 80$
TL204	0.029λ , 11.33Ω	$W = 7.62$, $L = 2.18$	$W = 300$, $L = 300$
TL205	0.091λ , 20.5Ω	$W = 3.81$, $L = 7.11$	$W = 150$, $L = 150$
TL206	0.029λ , 20.5Ω	$W1 = 3.81$, $W2 = 3.81$, $W3 = 2.29$	$W1 = 150$, $W2 = 150$, $W3 = 90$
TL207, TL216	0.000λ , 141.78Ω	$W = 0.03$, $L = 0.03$	$W = 1$, $L = 1$
TL208	0.009λ , 4.2Ω	$W = 22.35$, $L = 0.65$	$W = 880$, $L = 880$
TL209	0.021λ , 7.75Ω	$W = 11.61$, $L = 1.6$	$W = 457$, $L = 457$
TL210	0.013λ , 11.33Ω	$W = 7.62$, $L = 1.02$	$W = 300$, $L = 300$
TL211	0.017λ , 20.5Ω	$W = 3.81$, $L = 1.3$	$W = 150$, $L = 150$
TL212	0.100λ , 20.5Ω	$W = 3.81$, $L = 7.8$	$W = 150$, $L = 150$
TL213	0.003λ , 10.21Ω	$W1 = 8.56$, $W2 = 0.25$, $W3 = 8.56$, $W4 = 1.27$	$W1 = 337$, $W2 = 337$, $W3 = 337$, $W4 = 10$
TL214	0.021λ , 4.2Ω	$W1 = 22.35$, $W2 = 1.52$, $W3 = 22.35$, $W4 = 1.27$	$W1 = 880$, $W2 = 880$, $W3 = 880$, $W4 = 60$
TL215	0.049λ , 20.5Ω	$W1 = 3.81$, $W2 = 3.81$, $W3 = 3.81$	$W1 = 150$, $W2 = 150$, $W3 = 150$
TL217	0.016λ , 20.5Ω	$W = 3.81$, $L = 1.27$	$W = 150$, $L = 150$
TL218	0.034λ , 46.18Ω	$W = 1.27$, $L = 2.74$	$W = 50$, $L = 50$

(table cont. next page)

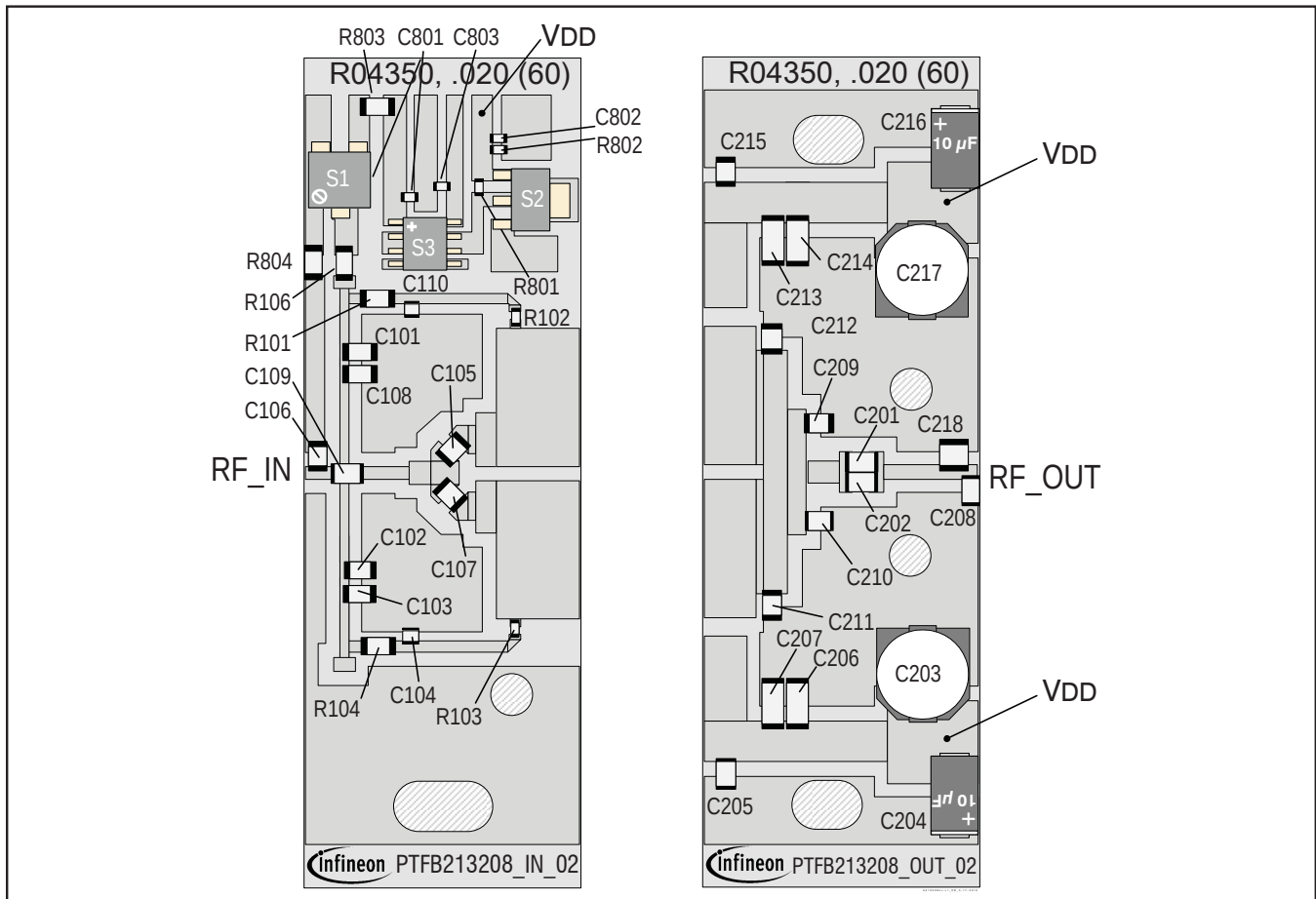
Reference Circuit (cont.)

Electrical Characteristics at 2170 MHz (output cont.)

Transmission Line	Electrical Characteristics	Dimensions: mm	Dimensions: mils
TL219	0.036λ , 34.02Ω	$W = 1.98$, $L = 2.84$	$W = 78$, $L = 78$
TL223, TL224	0.018λ , 100.15Ω	$W1 = 0.25$, $W2 = 0.25$, $W3 = 1.52$	$W1 = 10$, $W2 = 10$, $W3 = 60$
TL229, TL232	0.009λ , 8.46Ω	$W = 10.54$, $L = 0.65$	$W = 415$, $L = 415$
TL230, TL234	0.064λ , 7.13Ω	$W = 12.7$, $L = 4.8$	$W = 500$, $L = 500$
TL235	0.016λ , 20.5Ω	$W = 3.81$, $L = 1.27$	$W = 150$, $L = 150$
TL236, TL243	0.012λ , 11.33Ω	$W = 7.62$, $L = 0.94$	$W = 300$, $L = 300$
TL237, TL251, TL242	0.027λ , 11.33Ω	$W1 = 7.62$, $W2 = 7.62$, $W3 = 2.03$	$W1 = 300$, $W2 = 300$, $W3 = 80$
TL238, TL241, TL248	0.029λ , 20.5Ω	$W1 = 3.81$, $W2 = 3.81$, $W3 = 2.29$	$W1 = 150$, $W2 = 150$, $W3 = 90$
TL239	0.019λ , 46.18Ω	$W1 = 1.27$, $W2 = 1.27$, $W3 = 1.52$	$W1 = 50$, $W2 = 50$, $W3 = 60$
TL240	0.036λ , 46.18Ω	$W = 1.27$, $L = 2.97$	$W = 50$, $L = 50$
TL244	0.049λ , 20.5Ω	$W1 = 3.81$, $W2 = 3.81$, $W3 = 3.81$	$W1 = 150$, $W2 = 150$, $W3 = 150$
TL245	0.100λ , 20.5Ω	$W = 3.81$, $L = 7.8$	$W = 150$, $L = 150$
TL246	0.017λ , 20.5Ω	$W = 3.81$, $L = 1.3$	$W = 150$, $L = 150$
TL247	0.013λ , 11.33Ω	$W = 7.62$, $L = 1.02$	$W = 300$, $L = 300$
TL249	0.091λ , 20.5Ω	$W = 3.81$, $L = 7.11$	$W = 150$, $L = 150$
TL250	0.029λ , 11.33Ω	$W = 7.62$, $L = 2.18$	$W = 300$, $L = 300$
TL252	0.019λ , 46.18Ω	$W1 = 1.27$, $W2 = 1.27$, $W3 = 1.52$	$W1 = 50$, $W2 = 50$, $W3 = 60$, $= 0$

See next page for assembly information

Reference Circuit (cont.)



Reference circuit assembly diagram (not to scale)

Component ID	Description	Suggested Supplier	P/N
Input			
C101	Chip capacitor, 100,000 pF	PCC104BCT-ND	Digi-Key
C102, C108	Chip capacitor, 4,700,000 pF	493-2372-2-ND	Digi-Key
C103	Chip capacitor, 100,000 pF	PCC104BCT-ND	Digi-Key
C104, C110	Chip capacitor, 10.00 pF	ATC100A100JW150XB	ATC
C105, C107, C109	Chip capacitor, 10.00 pF	ATC100B100JW500XB	ATC
C106	Chip capacitor, 1.50 pF	ATC100B1R5CW500XB	ATC
C801, C802, C803	Chip capacitor, 1,000 pF	PCC1772CT-ND	Digi-Key

(table cont. next page)

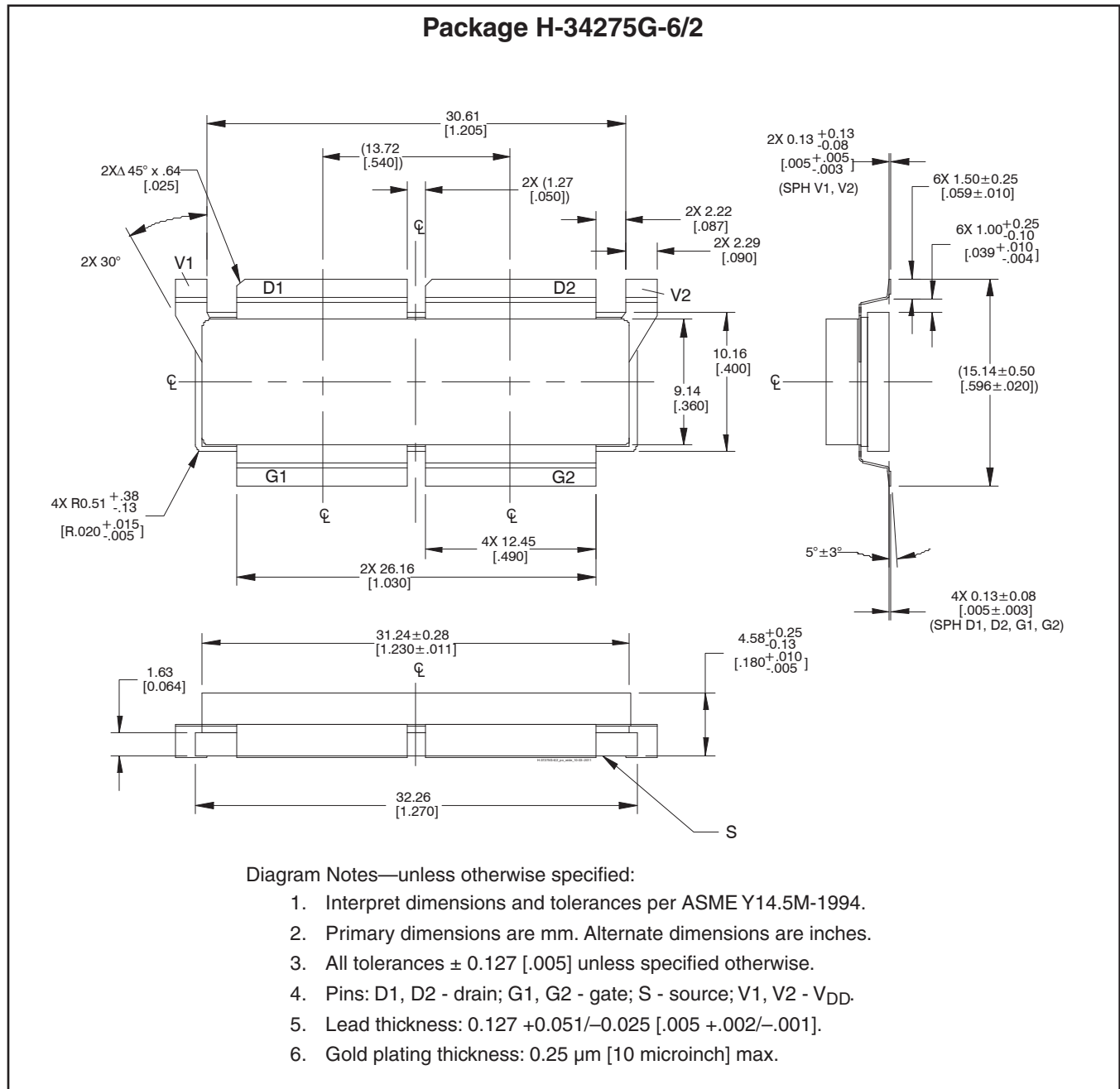
Reference Circuit (cont.)

Component ID	Description	Suggested Supplier	P/N
Input (cont.)			
R101	Resistor, 10 Ω	P10ECT-ND	Digi-Key
R102, R103	Resistor, 0.00 Ω	P0.0GTR-ND	Digi-Key
R104, R106, R804	Resistor, 10 Ω	P10ECT-ND	Digi-Key
R801	Resistor, 1,200 Ω	P1.2KGECT-ND	Digi-Key
R802	Resistor, 1,300 Ω	P1.3KGECT-ND	Digi-Key
R803	Resistor, 100 Ω	P100ECT-ND	Digi-Key
S1	Potentiometer	3224W-202ECT-ND	Digi-Key
S2	BCP56	BCP5616TA-ND	Digi-Key
S3	78051	LM7805	Digi-Key

Output

C201, C202	Chip capacitor, 10 pF	ATC100B100JW500XB	ATC
C203, C217	Capacitor, 100,000,000 pF	PCE4442CT-ND	Digi-Key
C204, C216	Capacitor, 10,000,000 pF	281M5002106K	Digi-Key
C205, C215	Capacitor, 10,000,000 pF	587-1818-2-ND	Digi-Key
C206, C214	Chip capacitor, 1,000,000 pF	445-1411-2-ND	Digi-Key
C207, C213	Chip capacitor, 2,200,000 pF	445-1447-2-ND	Digi-Key
C208	Chip capacitor, 0.20 pF	ATC100B0R2BW500XB	ATC
C209, C210	Chip capacitor, 0.30 pF	ATC100B0R3CW500XB	ATC
C211, C212	Chip capacitor, 1.30 pF	ATC100B1R3CW500XB	ATC
C218	Chip capacitor, 1.50 pF	ATC100B1R5CW500XB	ATC

Package Outline Specifications



Find the latest and most complete information about products and packaging at the Infineon Internet page
<http://www.infineon.com/rfpower>

Revision History: 2012-05-17

Data Sheet

Previous Version: Advance Specification, 2012-02-07

Page	Subjects (major changes since last revision)
all	Product released: Specifications updated; circuit and other information added

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highpowerRF@infineon.com

To request other information, contact us at:

+1 877 465 3667 (1-877-GO-LDMOS) USA

or +1 408 776 0600 International



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